

HIGH PERFORMANCE POLYAMIDE RESIN

Zytel[®] HTN51G50HSL BK083 is a 50% glass reinforced, heat stabilized, lubricated, hydrolysis resistant high performance polyamide resin. It is also a PPA resin.

Product information

Resin Identification Part Marking Code Part Marking Code ISO designation	PA6T/XT-GF50 >PA6T/XT-GF50< >PPA-GF50< ISO 16396-PA6T/XT,GF50,M1CGHR,S10-190		ISO 1043 ISO 11469 SAE J1344 190
Rheological properties	dry/cond.		
Moulding shrinkage, parallel Moulding shrinkage, normal	0.2/- 0.5/-	% %	ISO 294-4, 2577 ISO 294-4, 2577
Typical mechanical properties	dry/cond.		
Tensile Modulus Stress at break Strain at break Flexural Modulus Charpy impact strength, 23°C Charpy notched impact strength, 23°C Charpy notched impact strength, -40°C Poisson's ratio	17800/17800 262/245 2.1/2.1 16400/- 80/- 15/- 15/- 0.33/0.33	MPa MPa % MPa kJ/m² kJ/m² kJ/m²	ISO 527-1/-2 ISO 527-1/-2 ISO 527-1/-2 ISO 178 ISO 179/1eU ISO 179/1eA ISO 179/1eA
Thermal properties	dry/cond.		
Melting temperature, first heat Temp. of deflection under load, 1.8 MPa CLTE, Parallel, -40-23°C Coeff. of linear therm. expansion, parallel CLTE, Normal, -40-23°C Coeff. of linear therm. expansion, normal	300/* 265/* 14/* 14/* 45/* 48/*	°C °C E-6/K E-6/K E-6/K E-6/K	ISO 11357-1/-3 ISO 75-1/-2 ISO 11359-1/-2 ISO 11359-1/-2 ISO 11359-1/-2 ISO 11359-1/-2
Flammability	dry/cond.		
Burning Behav. at 1.5mm nom. thickn. Thickness tested Burning Behav. at thickness h Thickness tested Oxygen index FMVSS Class Burning rate, Thickness 1 mm	HB/* 1.5/* HB/* 0.85/* 24/* B 29		IEC 60695-11-10 IEC 60695-11-10 IEC 60695-11-10 IEC 60695-11-10 ISO 4589-1/-2 ISO 3795 (FMVSS 302) ISO 3795 (FMVSS 302)



HIGH PERFORMANCE POLYAMIDE RESIN

Other properties	dry/cond.	
Density	1640/- kg/m³	ISO 1183
Injection		
Drying Recommended	yes	
Drying Temperature	100 °C	
Drying Time, Dehumidified Dryer	6-8 h	
Processing Moisture Content	≤0.1 %	
Melt Temperature Optimum	325 °C	
Min. melt temperature	320 °C	
Max. melt temperature	330 °C	
Mold Temperature Optimum	150 °C	
Min. mould temperature	140 ^[1] °C	
Max. mould temperature	180 °C	
[1]: Higher temperature needed for thinner sections.		

Characteristics

Additives

Release agent

Additional Information

Injection molding

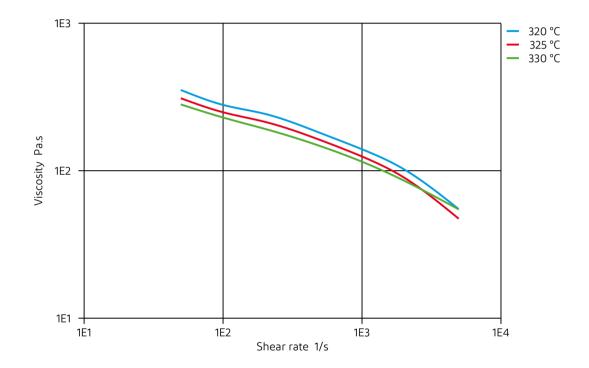
During molding, use proper protective equipment and adequate ventilation. Avoid exposure to fumes and limit the hold up time and temperature of the resin in the machine. Purge degraded resin carefully with HDPE.

When lower mold temperatures are used, the initial warpage and shrinkage may be lower, but the surface appearance and chemical resistance may be reduced, and the dimensional change may be greater when parts are subsequently heated.



HIGH PERFORMANCE POLYAMIDE RESIN

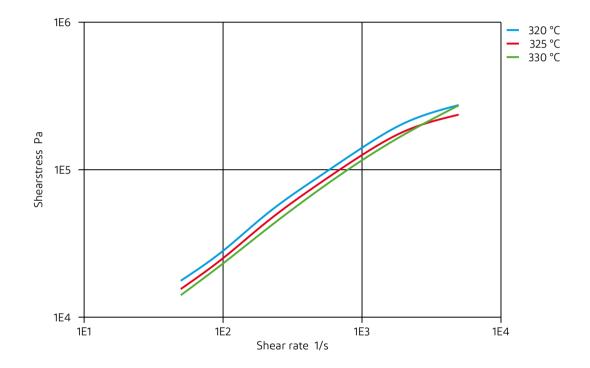
Viscosity-shear rate





HIGH PERFORMANCE POLYAMIDE RESIN

Shearstress-shear rate

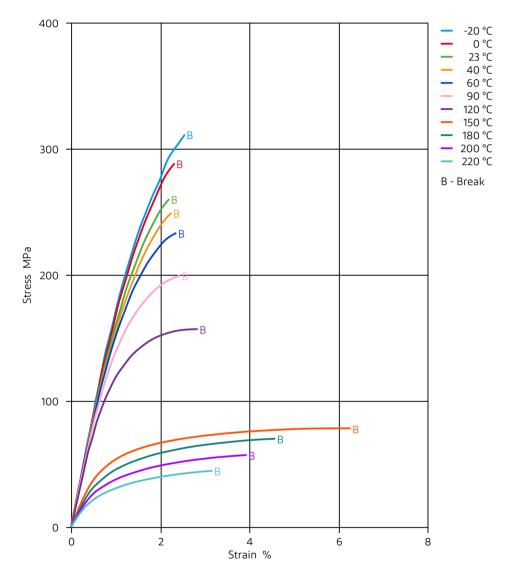




Zytel® HTN51G50HSL BK083

HIGH PERFORMANCE POLYAMIDE RESIN

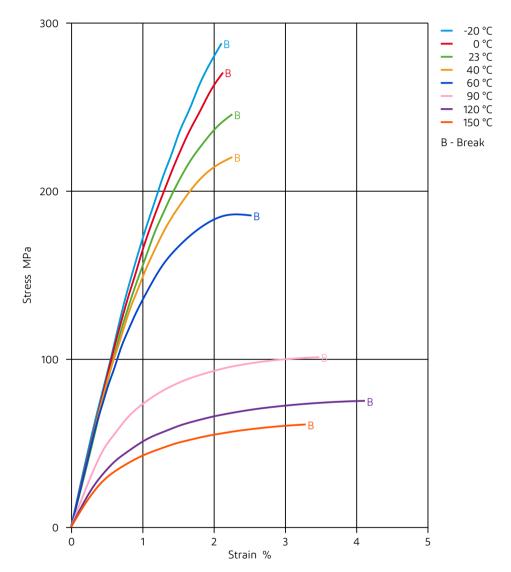
Stress-strain (dry)





HIGH PERFORMANCE POLYAMIDE RESIN

Stress-strain (cond.)

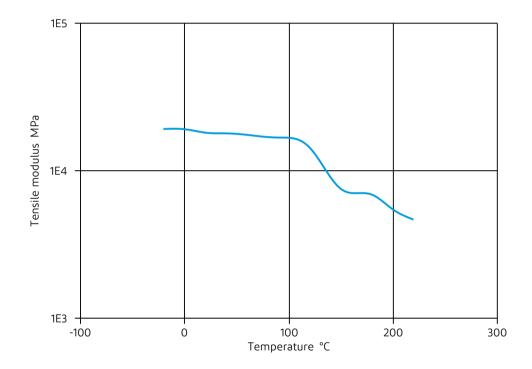


OUPONT>

Zytel[®] HTN51G50HSL BK083

HIGH PERFORMANCE POLYAMIDE RESIN

Tensile modulus-temperature (dry)

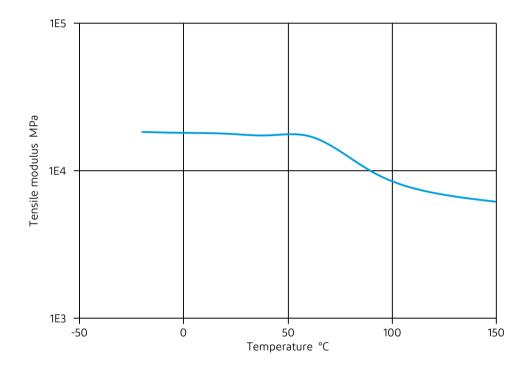


OUPONT>

Zytel® HTN51G50HSL BK083

HIGH PERFORMANCE POLYAMIDE RESIN

Tensile modulus-temperature (cond.)



OUPONT>

Zytel[®] HTN51G50HSL BK083

HIGH PERFORMANCE POLYAMIDE RESIN

Chemical Media Resistance

Acids

- ✓ Acetic Acid (5% by mass), 23°C
- ✓ Citric Acid solution (10% by mass), 23°C
- ✓ Lactic Acid (10% by mass), 23°C

Other

- ✓ Ethylene Glycol (50% by mass) in water, 108°C
- ✓ Water, 23°C
- ✓ Water, 90°C
- ✓ Coolant Glysantin G48, 1:1 in water, 125°C

Symbols used:

✓ possibly resistant

Defined as: Supplier has sufficient indication that contact with chemical can be potentially accepted under the intended use conditions and expected service life. Criteria for assessment have to be indicated (e.g. surface aspect, volume change, property change).

🗙 not recommended - see explanation

Defined as: Not recommended for general use. However, short-term exposure under certain restricted conditions could be acceptable (e.g. fast cleaning with thorough rinsing, spills, wiping, vapor exposure).

Revised: 2020-08-20

dupont.com

Page: 9 of 9

The information set forth herein is furnished free of charge, is based on technical data that DuPont believes to be reliable, and represents typical values that fall within the normal range of properties. This information relates only to the specific material designated and may not be valid for such material used in combination with other materials or in other processes. It is intended for use by persons having technical skill, at their own discretion and risk. This information should not be used to establish specification limits nor used alone as the basis of design. Handling precaution information is given with the understanding that those using it will satisfy themselves that their particular conditions of use present no health or safety hazards and use of this information. As with any product, evaluation under end-use conditions prior to specification is essential. Nothing herein is to be taken as a license to operate or a recommendation to infringe on patents.

CAUTION: Do not use DuPont materials in medical applications involving implantation in the human body or contact with internal body fluids or tissues unless the material has been provided from DuPont under a written contract or other acknowledgement that is consistent with the DuPont policy regarding medical applications and expressly acknowledges the contemplated use. For further information, please contact your DuPont representative.

DuPont's sole warranty is that our products will meet our standard sales specifications in effect at the time of shipment. Your exclusive remedy for breach of such warranty is limited to refund of purchase price or replacement of any product shown to be other than as warranted. TO THE FULLEST EXTENT PERMITTED BY APPLICABLE LAW, DUPONT SPECIFICALLY DISCLAIMS ANY OTHER EXPRESS OR IMPLIED WARRANTY OF FITNESS FOR A PARTICULAR PURPOSE, MERCHANTABILITY, OR NON-INFRINGEMENT. DUPONT DISCLAIMS LIABILITY FOR ANY SPECIAL, INCIDENTAL, OR CONSEQUENTIAL DAMAGES.

DuPont[™], the DuPont Oval Logo, and all trademarks and service marks denoted with [™], SM or [®] are owned by affiliates of DuPont de Nemours, Inc. unless otherwise noted. © 2021 DuPont. All rights reserved.